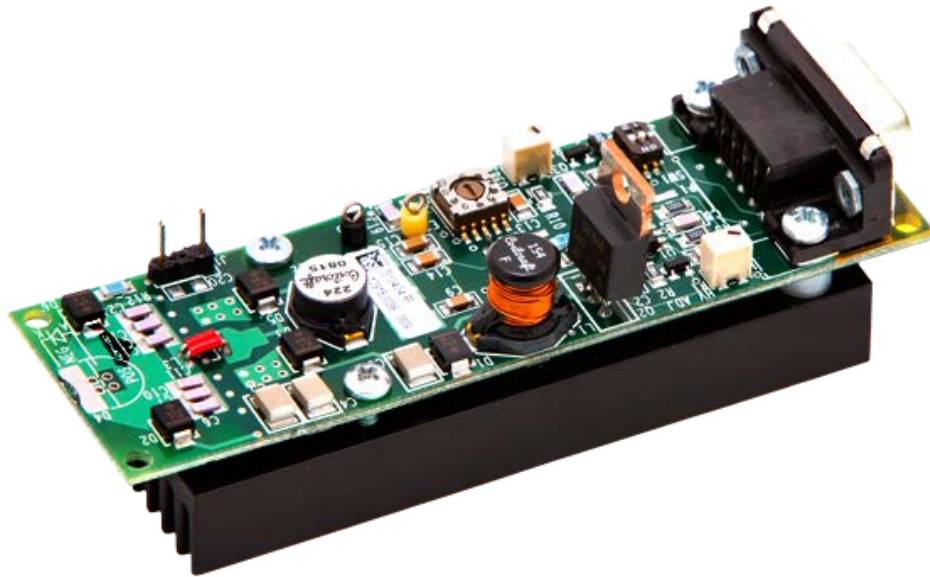




PCO-7810

Laser Diode Driver

Operation Manual



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Introduction

The PCO-7810 is a compact, economical, OEM pulsed laser diode driver module. It is designed to provide extremely fast, high-current pulses to drive laser diodes in range finder, LIDAR, atmospheric communications, and other applications requiring high-current nanosecond pulses.

The PCO-7810 features an internal trigger generator and an internal high-voltage DC power supply to support the high-current output. With the supplied heatsink, the PCO-7810-40-4 can operate at pulse repetition frequencies up to 200 kHz at 40 A output current. The PCO-7810-50-12 can operate at pulse repetition frequencies up to 67 kHz at 50 A output current. The PCO-7810-90-8 can operate at pulse repetition frequencies up to 20 kHz at 90 A output current.

The PCO-7810 is designed to be an OEM (Original Equipment Manufacturer)-style product in which the current pulse may be easily tailored to the diode type and application. Contact DEI for more information.

Mounting pads are provided to mount the laser diode directly to the driver. The four-hole mounting pattern accepts TO-18, TO-5, TO-52, 5.6 mm, and 9 mm packages (PerkinElmer Optoelectronics R, S, T and U packages), as well as other packages of similar dimensions and lead spacing, mounted perpendicular to the driver circuit board. To facilitate different packages and mounting preferences, there are two solder pads at the end of the board to accept various laser diode packages mounted on-axis to the driver. Furthermore, the diode can be connected remotely from the driver using a low-impedance stripline interconnection (available from DEI) between the mounting pads and the leads of the laser diode.

A current monitor output may be viewed with an oscilloscope, providing a straightforward means to observe the diode current waveform in real time.

The design is inherently temporally stable with large variations in ambient temperature, and is equally rugged with respect to mechanical parameters.

Design Considerations

Many elements and stray components may affect the PCO-7810 performance. One of the most important, which affects the performance greatly, is stray inductance. This is a combination of the output current loop's circuit elements and the physical inductance of that loop. The magnitude of this inductance has a great effect on the pulse width and the peak output current. The PCO-7810 design minimizes the stray inductance of the circuit components to approximately 2 nH. However, the laser diode that it will drive—and the means by which the diode is connected to the PCO-7810—also contribute to the stray inductance. This additional inductance, which is added to the system and will affect the output, is something that the user can minimize by appropriate diode package choice and interconnections between the diode and driver.

Table 1 lists several laser diode package types and their Equivalent Series Inductance (ESL). Although many of the laser diode packages have the appearance of a good, low-inductance design, they are not. For example, the 8-32 STUD (line #2) from all outward appearances is a low-inductance package; however, it has one of the largest ESL's of the devices listed. As shown in Table 1, this leaves the laser diode as the largest contributor of the total inductance.

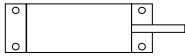




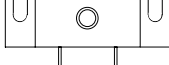

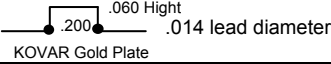
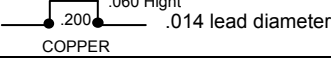
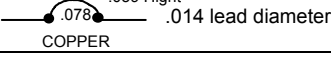
| # | PACKAGE STYLE | PACKAGE INDUCTANCE |
|----|--|--------------------|
| 1 |  Dip 14 Leads out top | 15.7nH |
| 2 |  8-32 STUD | 12nH |
| 3 |  10-32 STUD | 11nH |
| 4 |  TO-5 (2 lead) | 9.6nH |
| 5 |  TO-52 | 6.8nH |
| 6 |  Long Horn 14 Pin | 6.4nH |
| 7 |  CD9mm | 5.2nH |
| 8 |  KOVAR Gold Plate | 5.0nH |
| 9 |  COPPER | 3.6nH |
| 10 |  COPPER | 1.56nH |

Table 1 - Package Style vs. Package Inductance

Inputs and Control Functions

Table 2 below provides the pinouts of the DB-9 connector and connector J1. Figure 1 provides the component-side silkscreen of the PCO-7810 to facilitate locating the various components mentioned in this section.

The DB-9 connector is a standard 9-pin (male) DSUB connector (AMP 747250-4 or equivalent). It mates with a 9-pin DSUB socket (female) connector.

Connector J1 is the output of the current monitor. It is an FCI/Berg (www.berg.com) #65500-236 one-row header on 0.1" centers. The header mates with an FCI/Berg Mini-Latch Housing, part #65039-034 or equivalent, using FCI/Berg mating receptacles #48236-000 or equivalent.

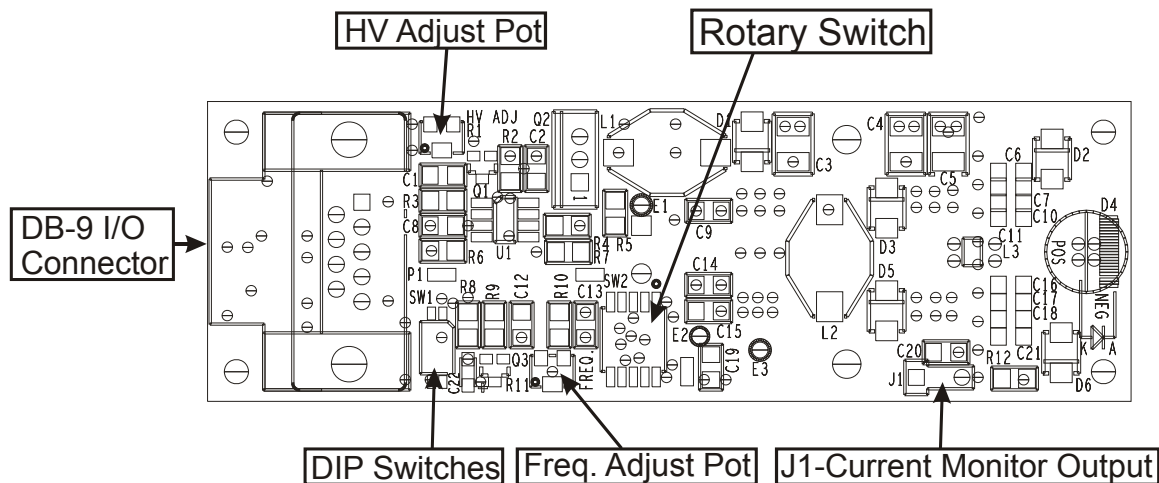
DB-9 Connector

| | |
|--------------|--|
| PIN 1 | GATE (CMOS into 1 k Ω) |
| PIN 2 | OSCILLATOR ENABLE (CMOS into 10 k Ω) |
| PIN 3 | HV BOOST DISABLE (CMOS into 1 k Ω) |
| PINS 4,5 | +24 V DC |
| PINS 6,7,8,9 | GND |

Connector J1

| | |
|-------|-----------|
| PIN 1 | GND |
| PIN 2 | CONDUCTOR |

Table 2 - PCO-7810 Connector Pinout



DB-9 Inputs

Referring to the above pinouts, there are four inputs to the PCO-7810 through the DB-9 connector: Trigger (GATE), Oscillator Enable, HV Boost Disable and Support Power (+24 V DC).

The **GATE** input is used for external triggering only. If the output is triggered by the internal oscillator, the GATE input is not required. If the GATE input is used, the PCO-7810 generates an output pulse on the leading edge of the gate input. The external trigger source should be capable of driving CMOS levels into 1 k Ω with a pulse width of 50 ns to 100 ns.

Rotary switch SW2 controls whether the internal oscillator or the external gate input is used to gate the driver. If SW2 is in position 1, a GATE input is required. If SW2 is in positions 2 through 8, the internal oscillator is used to set the output pulse frequency.

The **OSCILLATOR ENABLE** input enables the internal oscillator. If the driver is being triggered internally, the output may be turned on and off by enabling and disabling this input. The OSCILLATOR ENABLE input is internally pulled high. Therefore, if it is not connected or if it is connected to CMOS +5 V, the Oscillation function is enabled. If it is grounded, the Oscillation function is disabled.

The **HV BOOST DISABLE** input disables the internal high-voltage DC power supply. Please note that if the HV Boost is disabled, the DC power supply still generates a 24 V output. If the oscillator is enabled, this will result in a pulse of approximately 4 A (Model 40-4) on the output of the driver. Therefore, in order to completely disable the driver, either disconnect the input gate, disable the internal oscillator, and/or remove the +24 V DC input power. The disable is connected to CMOS +5 V to disable the HV power supply. If it is grounded or not connected, the power supply is enabled.

Rotary Switch Settings and Frequency Adjustment

FREQUENCY is adjusted using the FREQ adjust potentiometer and positions 1 through 8 of the Rotary Switch. Setting the Rotary Switch to the positions in Table 3 controls the range of the frequency. The potentiometer is then used to vary the frequency within this range (clockwise increases frequency, counter-clockwise decreases frequency). SW1 is used to lower the frequency further.

| Rotary Switch Position | Frequency Range |
|------------------------|---------------------|
| 1 | External Oscillator |
| 2 | 15 Hz to 60 Hz |
| 3 | 50 Hz to 240 Hz |
| 4 | 200 Hz to 985 Hz |
| 5 | 775 Hz to 3.8 kHz |
| 6 | 3.5 kHz to 15 kHz |
| 7 | 13 kHz to 63 kHz |
| 8 | 25 kHz to 126 kHz |
| 9 | 50 kHz to 245 kHz |
| 10 | Oscillator Off |

Table 3 - Rotary Switch Settings

AIR COOLING is required to operate at high frequencies. The 40-4 model requires cooling above 100 kHz. The 50-12 model requires cooling above 25 kHz. The 90-8 model requires cooling above 10 kHz.

Circuit Operation And Laser Diode Interconnection

The internal **high-voltage DC power supply** is capable of approximately 235 V maximum on the 40-4 and 50-12 models, and 410 V on the 90-8 model. The maximum average current that the high voltage supply must provide is determined by the pulse recurrence frequency required for the user's application.

Equation 1 has been derived in order to approximate ($\pm 20\%$) the current requirement (I_{PS}) of the high voltage power supply. It is a function of the total input capacitance (the Pulse Forming Network C_{PFN} , the FET capacitance C_{FET} , and the stray C_{STRAY}), the high voltage input (V_{IN}), and the frequency of each application (f).

$$1. I_{PS} = (C_{PFN} + C_{FET} + C_{STRAY}) * V_{IN} * f ,$$

where the various capacitances are given in Table 4.

| PCO-7810 MODEL | 40-4 | 50-12 | 90-8 |
|-----------------------|-------------|--------------|-------------|
| C_{PFN} | 500 pF | 2600 pF | 1540 pF |
| C_{FET} | 120 pF | 120 pF | 120 pF |
| C_{STRAY} | 200 pF | 200 pF | 200 pF |

Table 4 - C_{PFN} values of the PCO-7810

The output current of the PCO-7810 is adjusted by varying the DC power supply voltage using the potentiometer labeled HV ADJ. The output current depends upon the available charge of the C_{PFN} . This charge is directly proportional to the applied voltage. Therefore, varying the voltage will cause the output current to vary respectively.

WARNING! Various components on the driver are elevated to the potential of the high-voltage DC supply, as high as 235 V on the 40-4 and 50-12 and as high as 410 V on the 90-8. During operation, care must be taken not to touch any of the components on the driver. Failure to observe this precaution may result in electrical shock to the user.

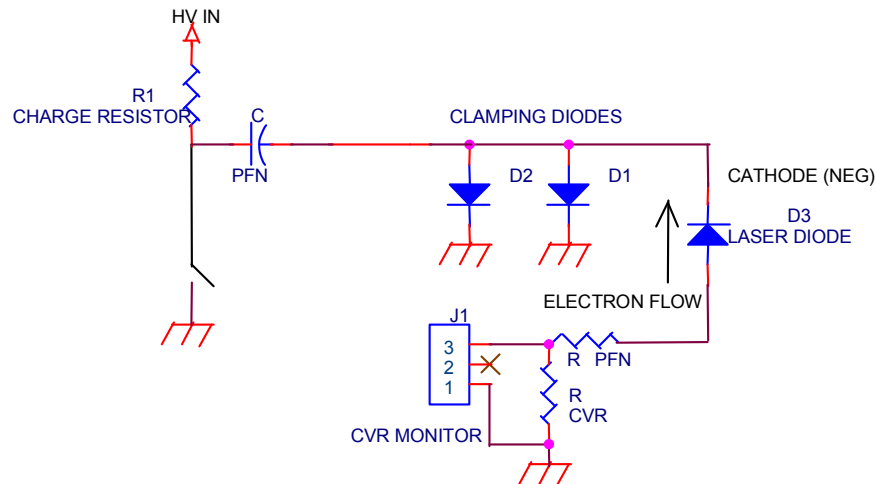


Figure 2 - Equivalent Circuit Diagram and Output Waveform

Figure 2 is the equivalent circuit diagram of the PCO-7810 pulse section. It shows the location of the C_{PFN} mentioned previously and the location of the laser diode with respect to the entire circuit. When monitoring the output waveform through J1, the waveform should approximate the one in Figure 2. For more details about current monitoring and output waveforms, refer to sections “Current Measurement” and “Typical Output Waveforms.”

D3 is the laser diode mounting location. It is marked on the silkscreen and is separated in the middle with a line. The right-most two holes are negative (NEG) for the cathode, while the other two are positive (POS) for the anode.

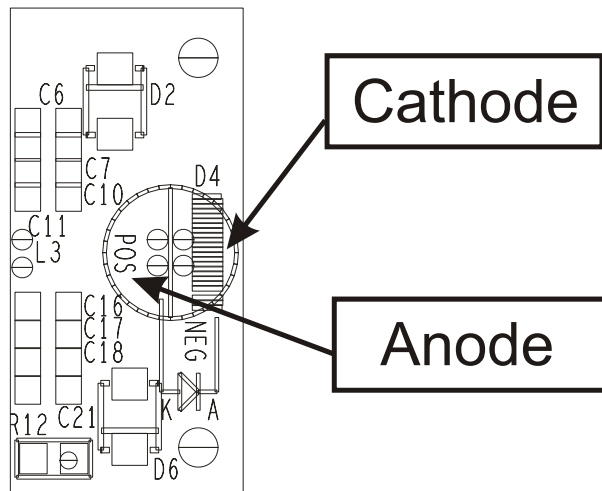


Figure 3 - Cathode and Anode Pads on the PCB

Figures 3 and 4 show where the cathode and anode are located on the board. It is very important to mount the diode properly to avoid damaging it.

To facilitate different packages and user preferences, there are two strips of exposed copper: one is on the top (component side) and one is on the bottom (circuit side) of the PC board.

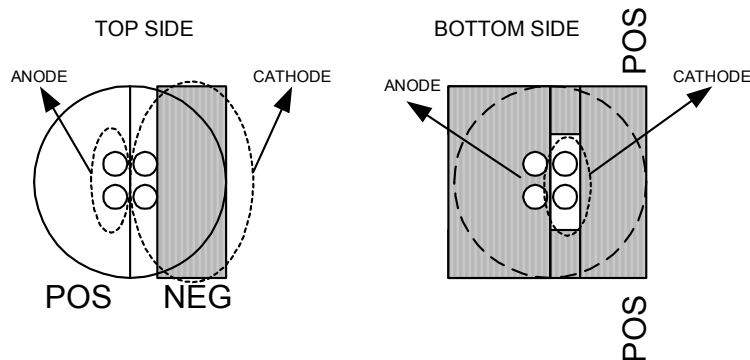


Figure 4 - Detailed View of Cathode and Anode Pads on the PCB

The one on top is marked NEG and is for the cathode of the diode, while the one on the bottom is marked POS for the anode.

These pads are provided to facilitate mounting the diode perpendicular to the edge of the board (axial mount) as shown in Figure 5, rather than using the mounting holes. A stripline interconnect may also be soldered to these pads. The laser diode can then be soldered to the opposite end of the stripline, allowing remote mounting or installation of the laser diode.

These pads have no soldermask. If the diode case is connected to the anode of the diode, it is necessary to use an insulator when mounting the diode radially. This insulator should be for a TO-18 package, and will prevent the diode case from shorting to one of the pads. The driver is provided with kapton insulators.

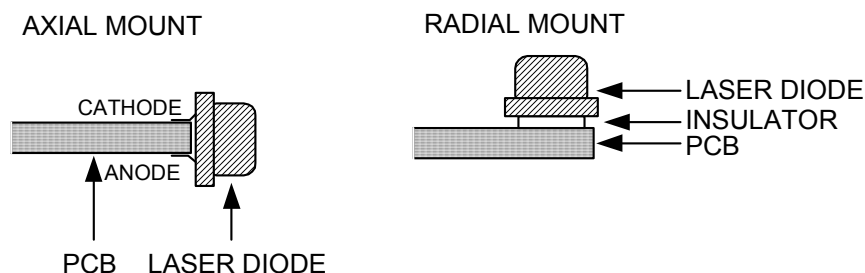


Figure 5 - Axial and Radial Mounting Positions

It is possible to mount the laser diode remotely using stripline. It is imperative that this stripline be of low inductance. As mentioned in the “Design Considerations” section, inductance can greatly affect the circuit performance. Stripline material designed for use with the PCO-7810 is available from DEI (part number 1820-0030).

Current Measurement

The current monitor signal provided on the PCO-7810 is available through connector J1. The output waveform will look very similar to that in Figure 2. Waveform photographs from an oscilloscope through the driver's internal monitor are included in the "Typical Output Waveforms" section.

The physical topology of the PCO-7810's current monitor resistors yields a Current Viewing Resistor (CVR) with a bandwidth of approximately 500 MHz. The scaling is 40 A per 1 V into a 50 Ω oscilloscope input.

The current monitor is not able to display a perfect rendition of the current given the peak and speed of the pulse. Because of the speed of the pulse, and some stray inductance and capacitance, there can be ringing on the viewing resistor. Pin 1 on connector J1 is the signal and pin 2 is the ground. For the best viewing results, solder the coaxial cable directly to the connector.

Specifications

The specifications in Table 5 below are for the standard models. For OEM applications, the PCO-7810 can be configured to specific pulse width and output current levels to meet individual customer requirements. Contact DEI for more information.

| SPECIFICATIONS | | | |
|--|---|-------------|--------------|
| PCO-7810 MODEL | 40-4 | 50-12 | 90-8 |
| Pulse Output Current Range (controlled by HV adjust potentiometer mounted on board; clockwise rotation increases output current) | 4 A to 40 A | 5 A to 50 A | 13 A to 90 A |
| Pulse Width (FWHM at maximum output current) | 4 ns ±1 ns | 12 ns ±2 ns | 8 ns ±1 ns |
| Rise Time (10% - 90%, typical) | <2 ns | 2.5 ns | <4.5 ns |
| Maximum PRF (Pulse Recurrence Frequency) at maximum output current | 200 kHz | 67 kHz | 20 kHz |
| Maximum Duty Cycle (CW at maximum output current) | 0.08% | | |
| Jitter (1st Sigma) | <1 ns | | |
| Throughput Delay (delay from external input trigger to output pulse) | 33 ns Typical | | |
| Maximum Overshoot at maximum output current | 5% | | |
| Output Current Monitor | 40 A/V into 50 Ω | | |
| Trigger In (optional) | CMOS into 1 kΩ, 50 ns to 100 ns pulse width, <10 ns rise time | | |
| HV Boost Disable Input (connect to CMOS +5 V to disable the HV power supply; ground or leave unconnected to enable) | CMOS into 1 kΩ | | |
| Oscillator Enable Input (connect to ground to disable the Oscillation function; leave unconnected or connect to CMOS +5 V to enable) | CMOS into 1 kΩ | | |
| Support Power | +24 V DC | | |
| MECHANICAL | | | |
| Input Connector (for +24 VDC, HV Disable input, Oscillator Disable input, and External Pulse input) | DSUB 9 pin (AMP 747250-4 or equivalent) | | |
| Length | 4.00 inches (10.16 cm) | | |
| Width | 1.25 inches (3.18 cm) | | |
| Height (including heatsink) | 1.4 inches (3.56 cm) | | |
| Weight (Approximate, including heatsink) | 2.9 oz. (82 grams) | | |
| Operating Temperature | -20° C to +85° C | | |
| • ALL SPECIFICATIONS MEASURED INTO A SHORTED OUTPUT AND MEASURED WITH THE INTERNAL CURRENT MONITOR | | | |
| • SPECIFICATIONS SUBJECT TO CHANGE WITHOUT NOTICE | | | |
| • LASER DIODE NOT INCLUDED | | | |

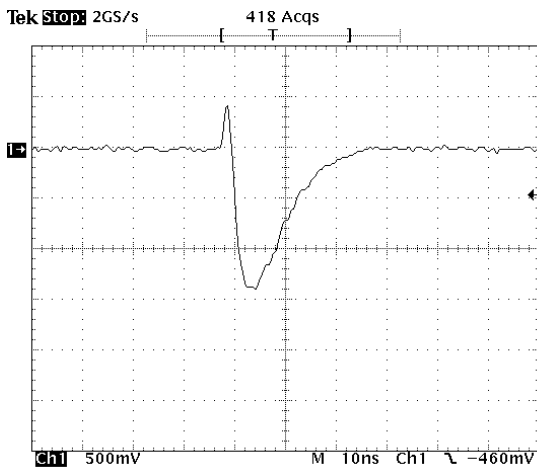
Table 5 - PCO-7810 Specifications

Figure 6 contains the dimensions for the PCO-7810. The mounting holes in the four corners (labeled “B”) are 0.125 inch through holes to clear a #4 screw.

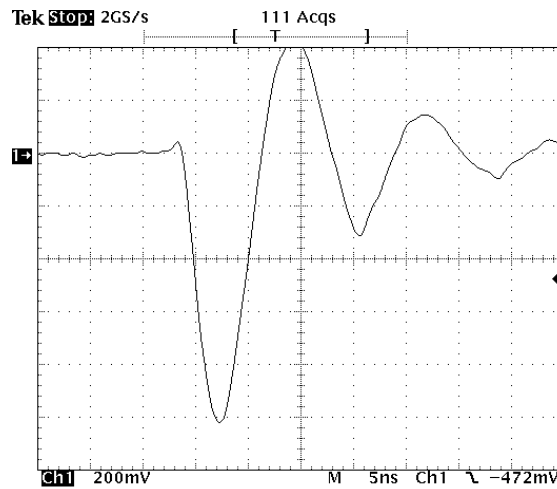


Typical Output Waveforms

The output waveforms in Figure 7 are typical when driving a short circuit in place of a laser diode.



Model 50-12 Typical Output Waveform
12 ns pulse width, 50 A output
horizontal scale, 20



Model 40-4 Typical Output Waveform
4 ns pulse width, 40 A output
5 ns/div horizontal scale, 20 A/div vertical scale

Figure 7 - Typical Output Waveforms

Control Cable

Figure 8 is a schematic diagram of the supplied control cable.

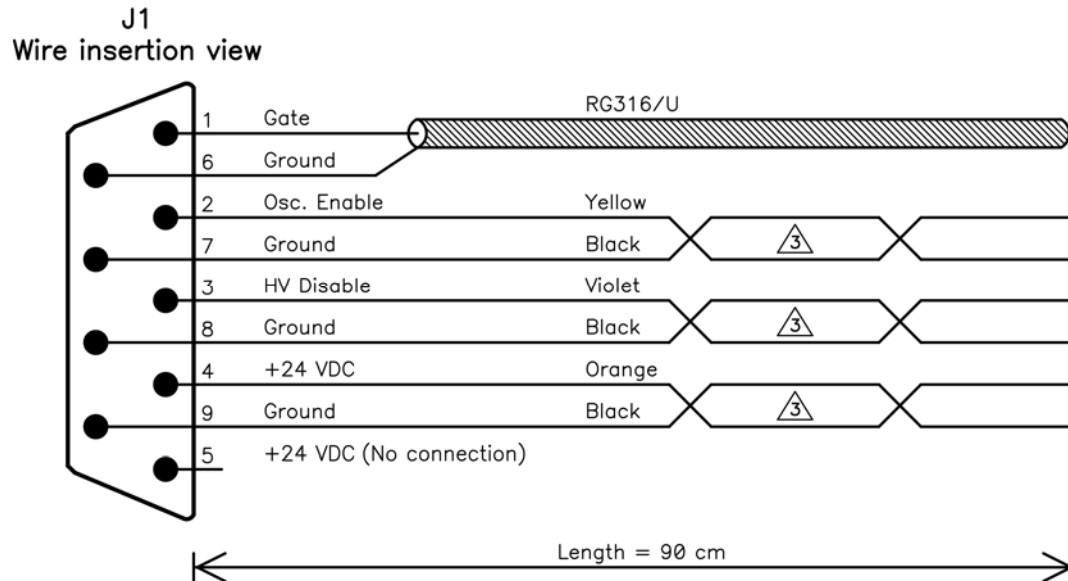


Figure 8 - Control Cable Schematic

Warranty

There are no warranties, express or implied, including any implied warranty of fitness for a particular purpose nor any IMPLIED WARRANTY OF MERCHANTABILITY made by DEI Scientific (DEI) except as follows:

DEI warrants equipment manufactured by it to be free from defects in materials and/or workmanship under conditions of normal use for a period of one year from the date of shipment to the purchaser. DEI will repair or replace, at DEI's option, any product manufactured by it which is shown to be defective or fails to perform within specifications within one year from the date of shipment to the purchaser. OEM, modified and custom items of equipment are similarly warranted, for a period of ninety (90) days from date of shipment to the purchaser.

Equipment claimed to be defective must be returned, transportation prepaid, to DEI's factory in Fort Collins, Colorado within the warranty period. Returns must be preauthorized by contact with DEI's customer service department. Written documentation of such preauthorization shall be included with the returned item.

At DEI's discretion, DEI may elect to repair or replace the equipment claimed to be defective or refund the original purchase price, plus taxes and transportation charges incurred by the purchaser.

This Warranty shall not apply to any product that has been:

1. Repaired, worked on, or altered by persons unauthorized by DEI;
2. Subjected to misuse, neglect, or damage by others; or
3. Connected, installed, adjusted, or used in a manner not authorized in the instructions or specifications furnished by DEI.

This warranty is the purchaser's sole remedy for claimed defects in the equipment sold or manufactured by DEI. DEI's liability to the purchaser is limited to the repair or replacement of the claimed defective equipment or, at DEI's option, refund of the purchase price, taxes and transportation charges incurred by the purchaser. DEI will not be responsible for or liable to the purchaser for consequential losses or damages asserted to be attributable to a claimed defect in the equipment provided.

Changes made by DEI in the design or manufacture of similar equipment which are effected subsequent to the date of shipment of the warranted equipment to the purchaser are reflective of DEI's program of constant product development and improvement and shall not be construed as an acknowledgement of deficiency in the product shipped to purchaser. DEI will be under no obligation to make any changes to product previously shipped.